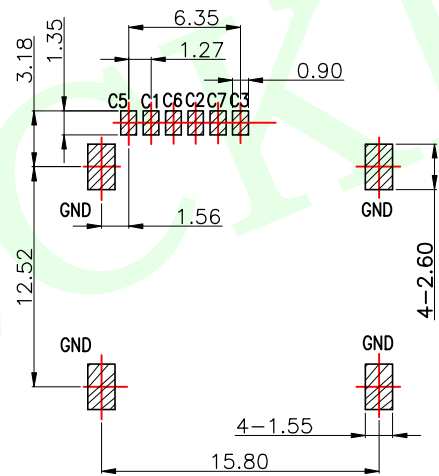
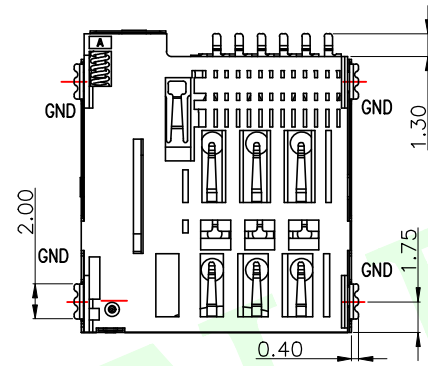
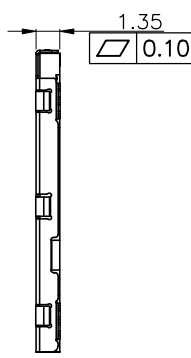
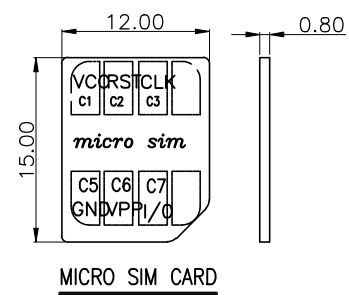
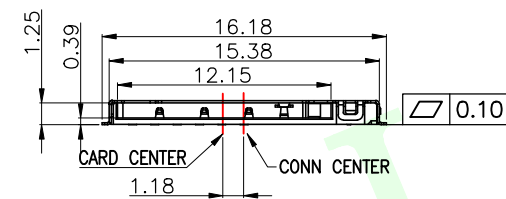
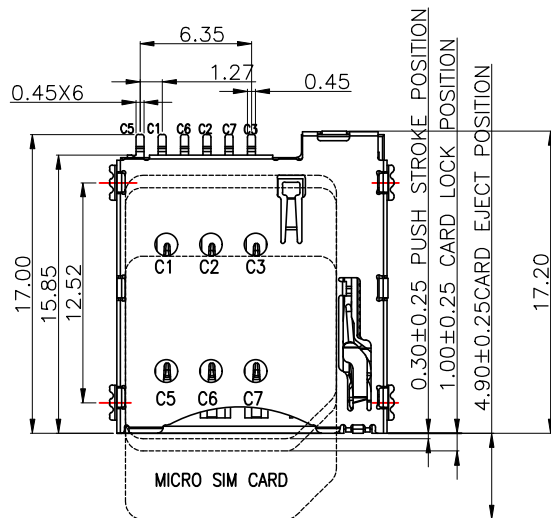


RoHS Compliant

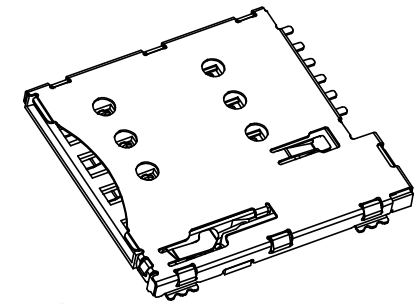


SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

■ CIRCUIT TRACE KEEP OUT AREA
■ SMT SOLDER AREA

THERE SHOULD NOT BE ANY CIRCUITRIES
IN THE LAYOUT SPACE OF THE PRODUCTS.

RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ± 0.05



NOTES:

MATERIAL:

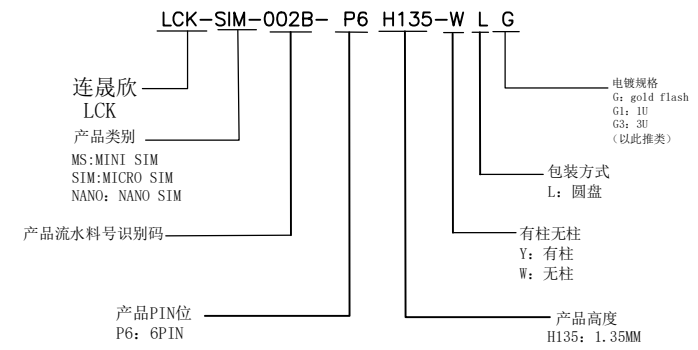
Insulator: High Temperature Thermoplastic,
Contact: Copper Alloy
Shell: STAINLESS

PLATING:

Contact: Plated 30u" Ni Overall ,Solder Area: Tin,Contact G/F
Shell: Plated 30u" Ni Overall
Plated G/F Selective Contact Area

Electrical:

Current Rating :0.5A AC/DC max.
Voltage Rating :50V AC/DC MAX
Ambient Temperature Range : $-20^{\circ}\text{C}\sim+85^{\circ}\text{C}$
Storage Temperature Range : $-40^{\circ}\text{C}\sim+70^{\circ}\text{C}$
Ambient Humidity Range :95% R.H. Max.
Contact Resistance:100m Ω max.
Insulation Resistance:1000M min./250V DC
Dielectric Withstanding Voltage:500V AC
Mating Cycles:5,000 Insertions
Temperature: $260^{\circ}\text{C} \pm 5^{\circ}$



MEASURE POINT:
QUADRANT POINT (QP)
TANGENCY POINT (TP)
INTERSECTION POINT (IP)

UNLESS OTHERWISE
SPECIFIED, TOLERANCE:
X. ± 0.25
X.x ± 0.20
X.xx ± 0.15
ANGULAR $\pm 3^{\circ}$



联晟欣连接器（深圳）有限公司
Lianshengxin Connector (Shenzhen) Co., Ltd

DESIGN	Andy	DATE	2014.12.24	TITLE:	MICRO SIM PUSH PUSH 1.35H		
CHECKED		DATE			6P无柱		
APPROVED		DATE					
PART NO:	LCK-SIM-002B-P6H135-WLG	REV:	04	SCALE:	1:1	UNIT:	mm
DRAWING NO:		SIZE:	A4	SHEET:	1/1		